

# **Memory Module Specifications**

R&D | OEM | ODM SSD & DDRAM

#### ST21D4N12S808G

### SemiTank S8 8GB DDR4 2133 SO-DIMM

#### **DESCRIPTION**

This document describes DDR4 260 Pin SO-DIMM Non ECC, P/N: ST21D4N12S808G. This Memory Module based on Capacity 8GB, Frequency 2133 Mhz, Latency CL15, Data Transfer Bandwidth 17.000 MB/s. DDR4 260 Pin SO-DIMM Non ECC uses gold contact fingers and used for:

- \* Laptop.
- \* All in One Computer.
- \* Industrial Computer.
- \* Mini Computer.

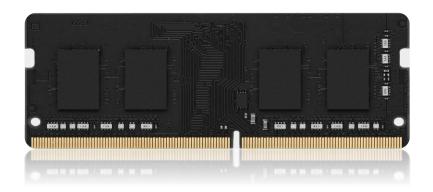
The electrical and mechanical specifications are as follows:

#### **Feature**

- Increased Fundamental Frequency, Faster Speeds.
- Unleashed Capacity, Stronger, Multitasking.
- Improved Structural Composition, Greater Efficiency.
- Reduced Working Voltage. Better Energy Efficiency.
- RoHS Compliant and Halogen-Free.

#### **SPECIFICATIONS**

| Module type             | DDR4 260 Pin SO-DIMM Non ECC |
|-------------------------|------------------------------|
| Product Dimensions      | 69.6*30*3.37 mm              |
| Series                  | S8 Series                    |
| Frequency               | 2133 Mhz                     |
| Latency                 | CL15                         |
| Data Transfer Bandwidth | PC3 17000 17.000 MB/s        |
| Capacity                | 8GB                          |
| Voltage                 |                              |
| Voltage                 | 1.2V                         |
| Operating Temperature   | 1.2V<br>0°C to +70°C         |
| -                       |                              |
| Operating Temperature   | 0° C to +70° C               |



## \*Note:

- We reserve the right to modify product specifications without prior notice.
- Check "Product Compatibility Inquiry" before purchase for further info.